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Advancing the Pixelated Resistive Silicon Readout and Charge Collection Techniques

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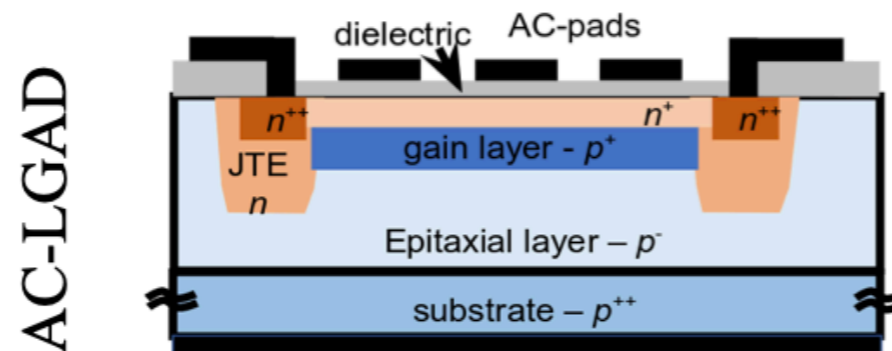
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Introduction

- Low Gain Avalanche Diodes (LGADs) and AC-coupled Low Gain Avalanche Diodes (AC-LGADs):

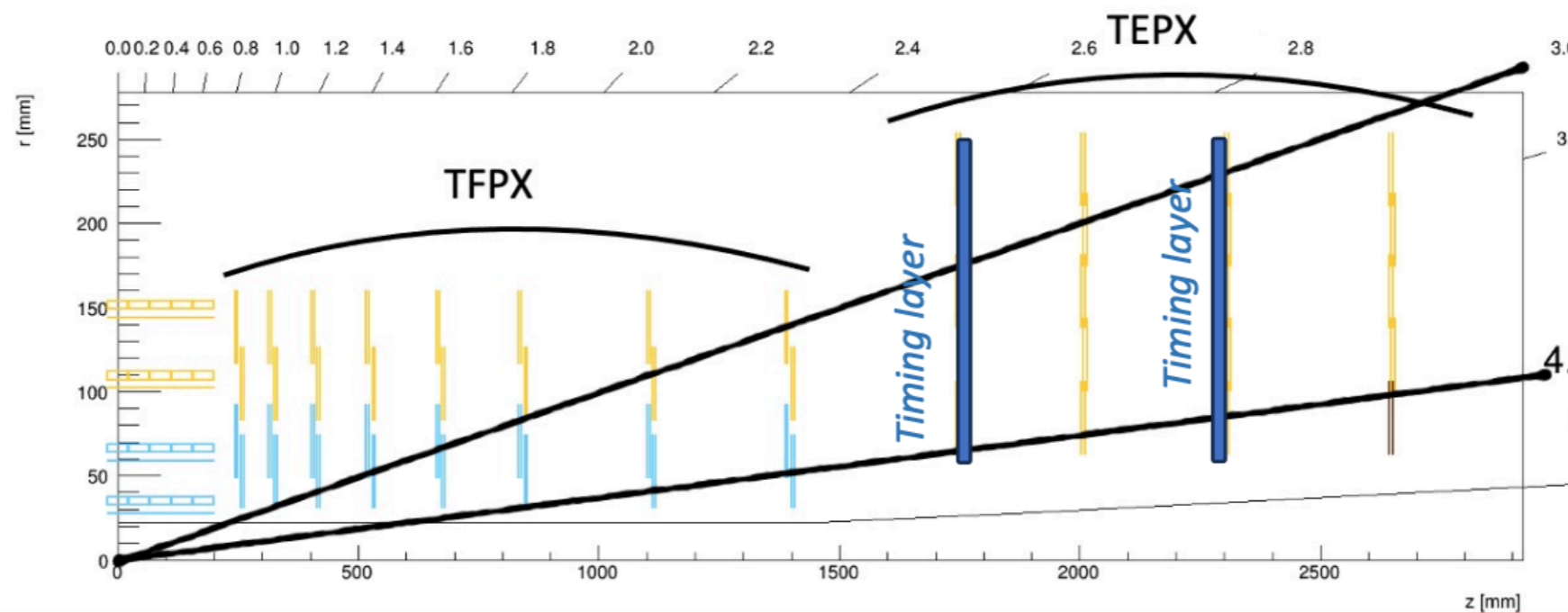


AC-LGAD

- ▶ AC-pad coupled to the resistive n^{+} layer via dielectric coupling
- ▶ Not segmented gain layer: 100% fill factor
- Good spatial resolution with a relaxed pitch
 - ▶ $O(30)$ ps timing performance and 4D extension with $O(10)$ μm spatial resolution in RSD variant
- Applications:
 - ▶ Electron-Ion Collider, LHCb Velo Upgrade, CMS tracker Phase-3 upgrade, FCC-ee.
 - ▶ Time of Flight Applications
 - ▶ Medical applications.

Introduction

- High Energy Physics Applications in low to moderate radiation regimes: FCC-ee and LHC upgrades:
- High-Luminosity LHC:
 - ▶ LHCb Velo Upgrade, CMS tracker Phase-3 upgrade:
 - ◆ Extension of CMS timing capabilities in the forward region (currently ETL)
 - ◆ Higher rapidity coverage
 - ◆ Replace one or two disks, instrumenting them with (AC)LGADs



- FCC-ee:
 - ▶ Timing capabilities in the outermost silicon
 - ▶ Enhance particle identification
 - ▶ Reduce the systematic uncertainty on beam energy .

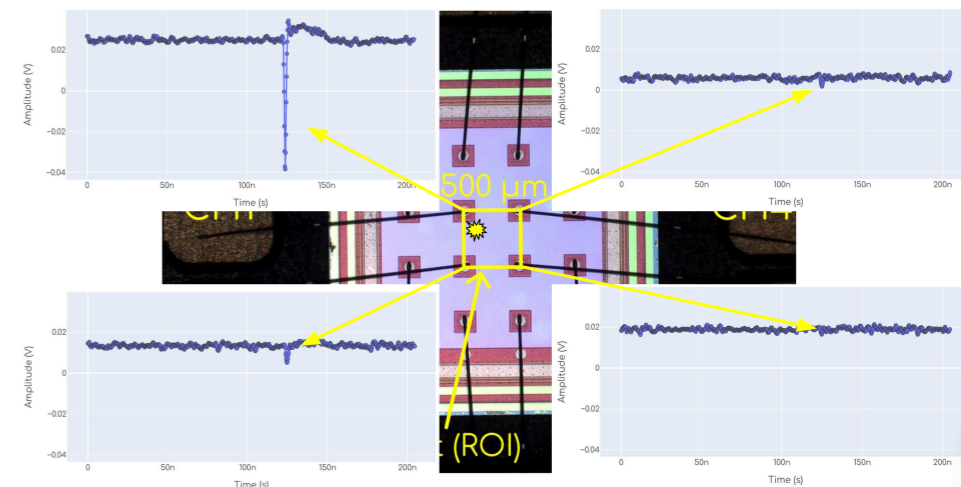
Charge sharing

- Increased charge-sharing is an intrinsic property of RSD/AC-LGADs.

- ▶ With α_i the area of each pad i and for r_i the distance between the true hit and the pad i , the signal seen by each pad:

$$S_i = \frac{\alpha_i / \ln r_i}{\sum_i^n \alpha_i / \ln r_i}$$

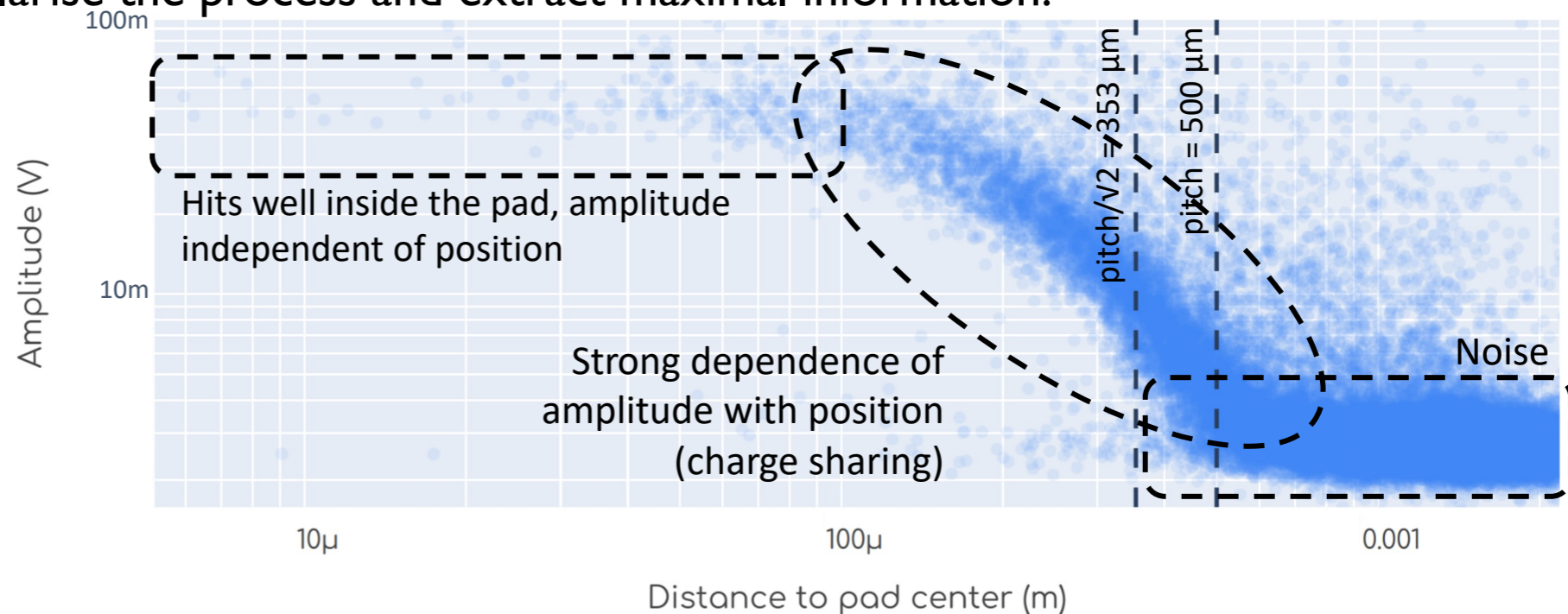
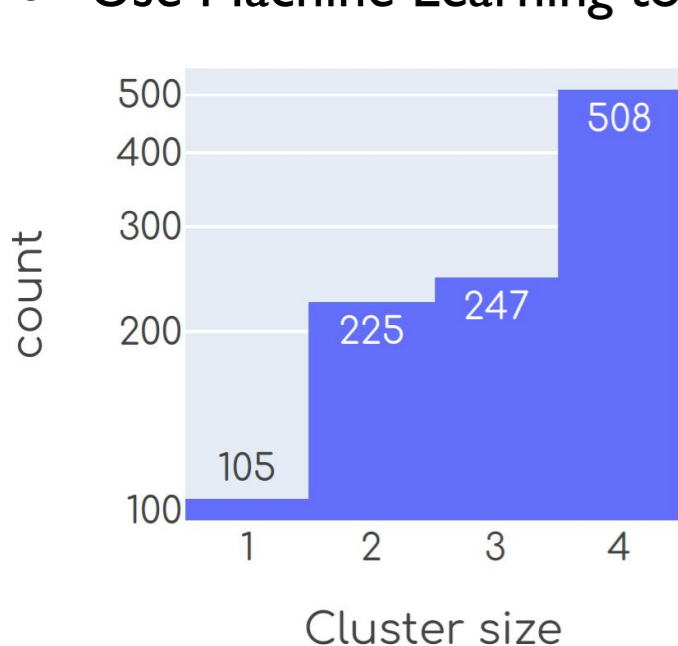
- ▶ Waveforms from all pads coupled $\rightarrow n \times n$ problem.



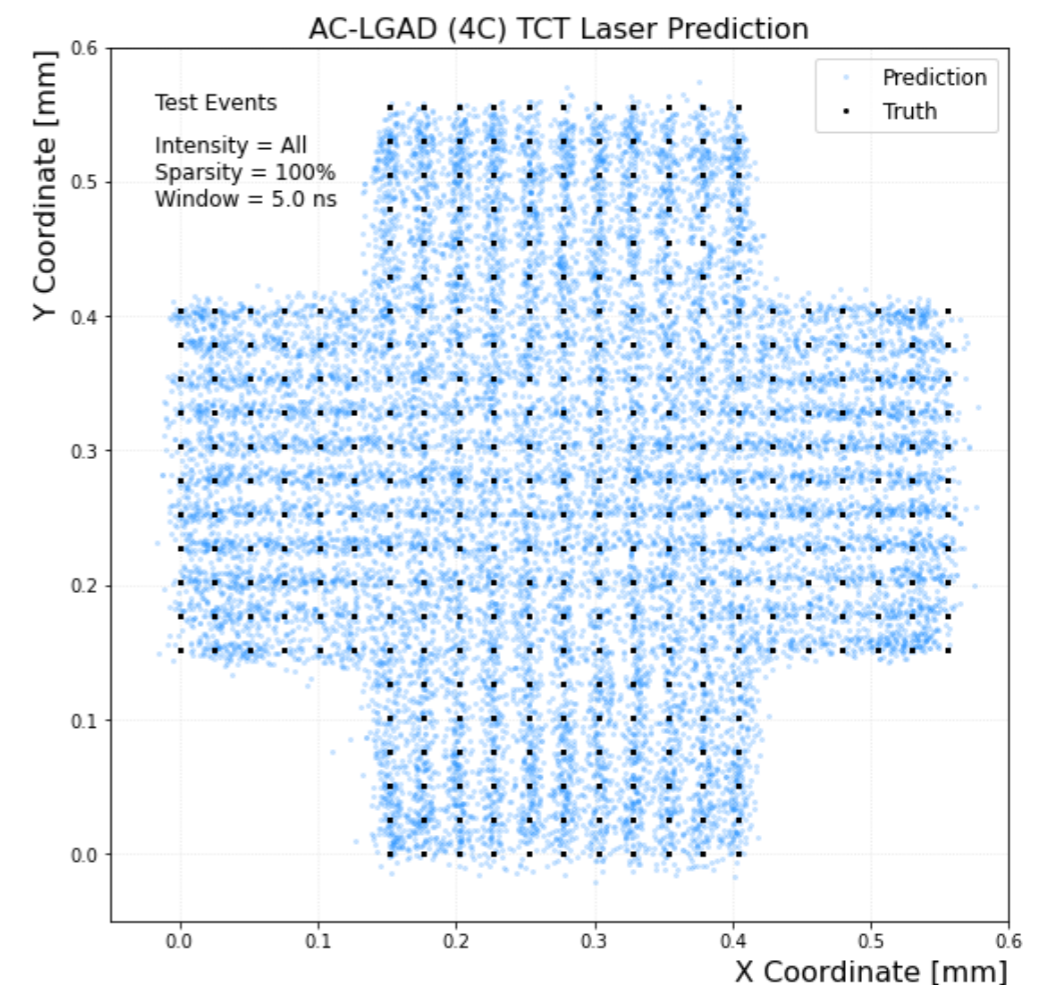
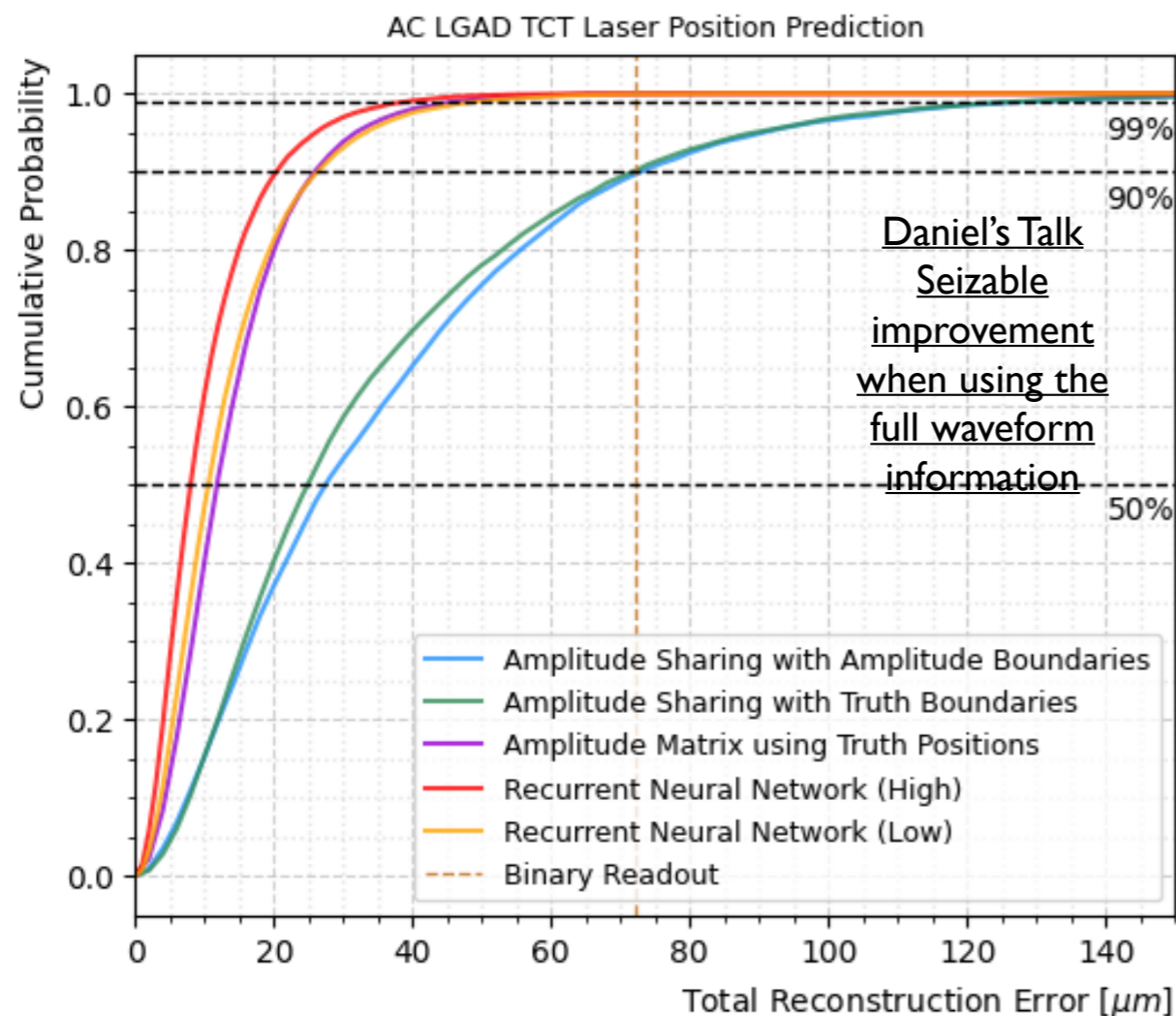
- Noise threshold traditionally puts a limit on the amount of useful *information* in the sharing.

- ▶ How much more information can be recovered?
- ▶ Multiple correlated signals, matrix inversion for position determination:
 - ◆ Computationally challenging.
 - ◆ Off-diagonal noise leads to large fluctuations and biases.

- Use Machine Learning to regularise the process and extract maximal information.

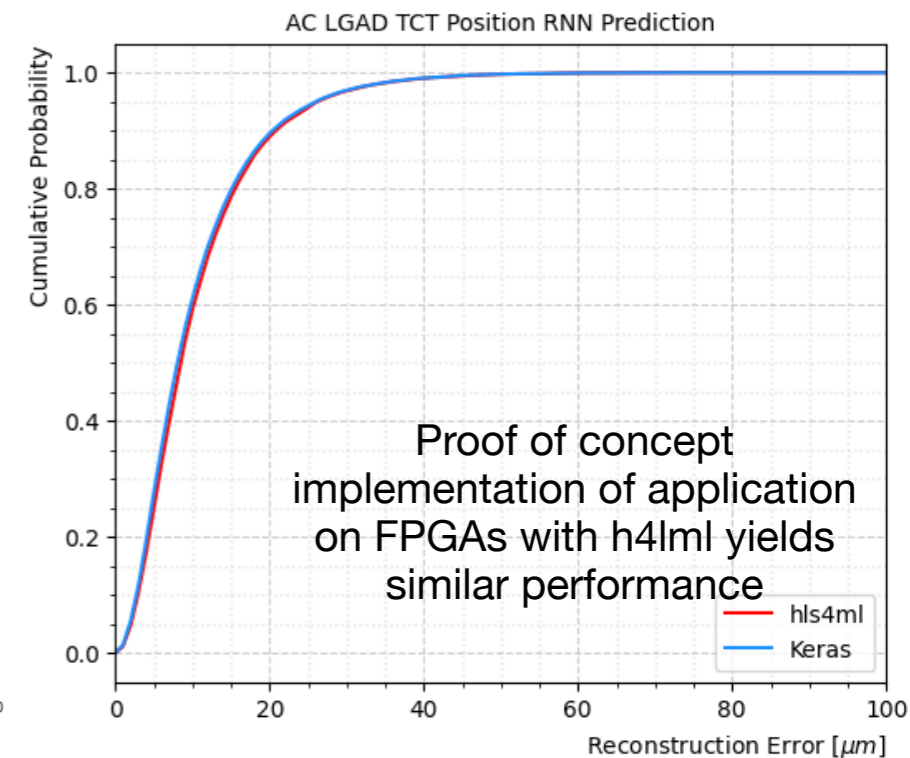
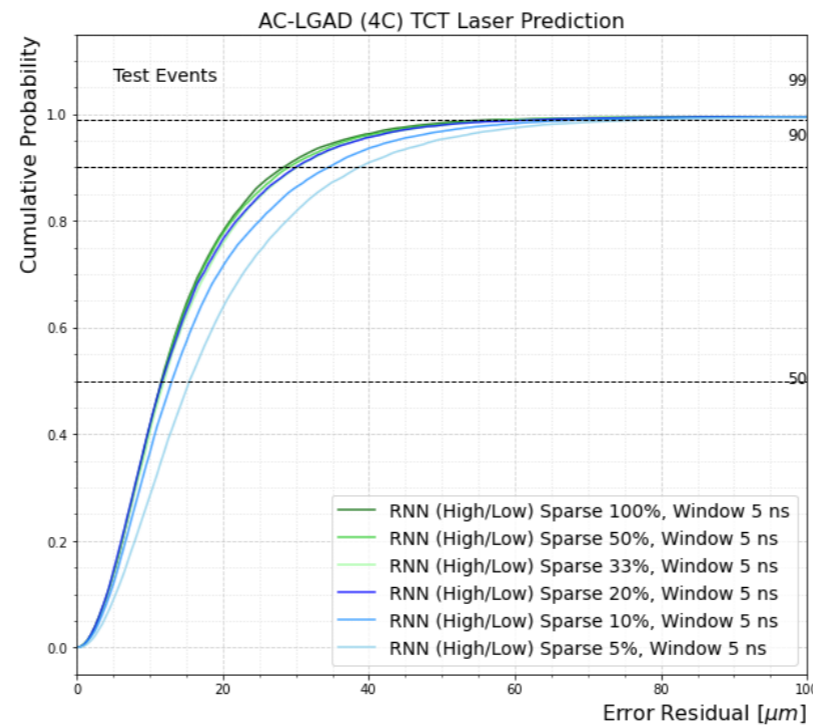
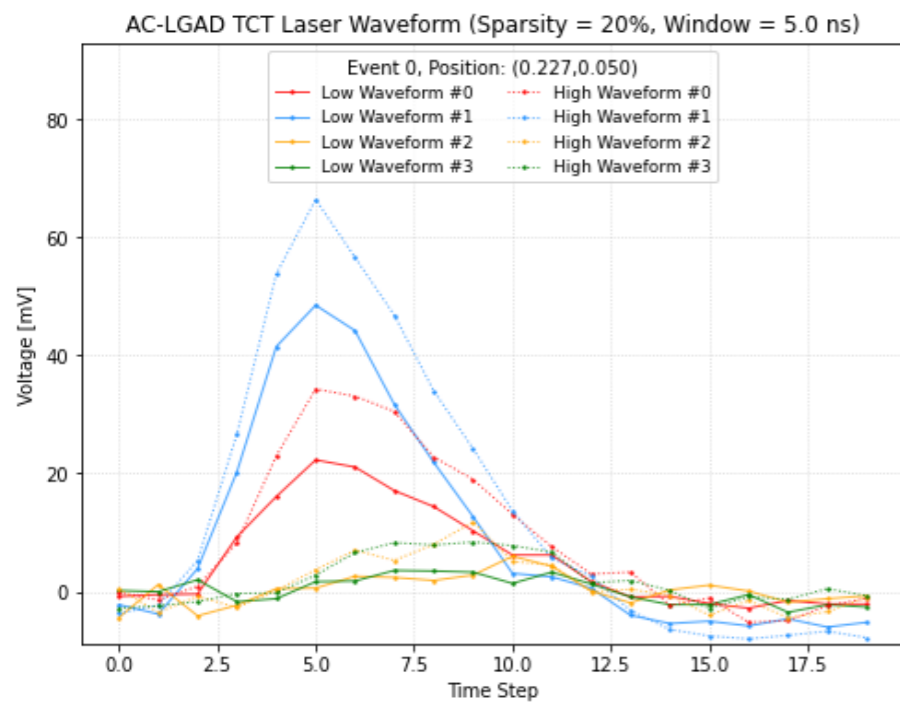


- Use Machine Learning to regularise the process and extract maximal information.
 - ▶ Independent of pad arrangement → optimal geometry maximizes position resolution.
 - ▶ Full waveform processing → harness shape correlations between leading and all pads.
 - ▶ Harness all the information from all the pads, including correlations → improvement of the position resolution.
- Preliminary studies using the full digitized amplitude instead of relative amplitude fractions
 - ▶ On lasers indicate a potential resolution of $\sim 10 \mu\text{m}$ from pixels with $500 \mu\text{m} \times 500 \mu\text{m}$
 - ▶ Previous studies using relative amplitude fractions on less advanced networks:
 - ◆ $\sim 20 \mu\text{m}$ on same sensor with laser and $\sim 44 \mu\text{m}$ on MIPs



Challenges

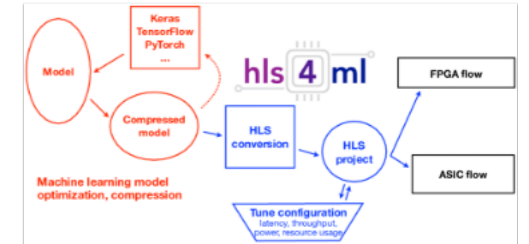
- Challenges:
- Landau fluctuations:
 - ➔ Use laser-assisted test beam (MIP) training.
 - ➔ Parametrization as a function of deposited charge.
- Degradation in performance with radiation damage
 - ➔ Parametrization as a function of given fluences.
- ASIC/readout electronics limitation:
 - ➔ Implement processing in off-detector electronics, FPGA
 - ➔ Wave-form rasterization in training/evaluation: preliminary still 10-15 μm resolution on 500 μm x 500 μm pixels.



Deliverables

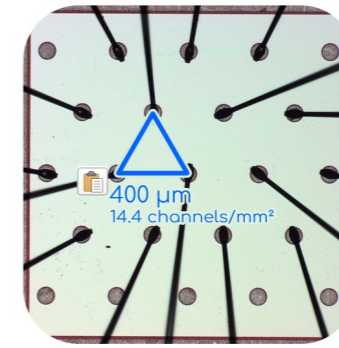
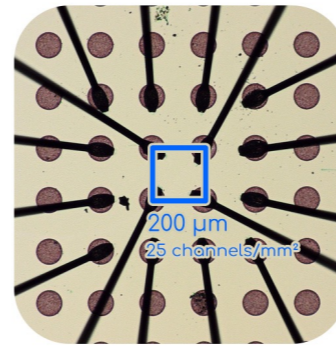
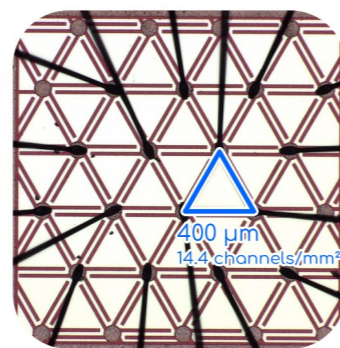
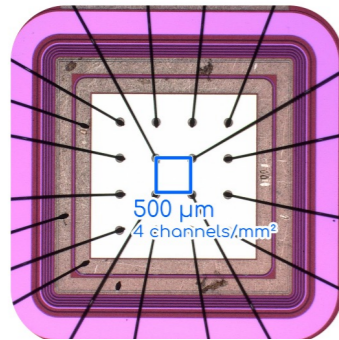
- Our goal:

- ▶ Combining the response from infra-red laser measurements and the responses from test-beam operations as a function of the irradiation dose of the sensors to construct a laser-assisted ML map capable of weighting out the proportion of intrinsic noise.



- **O1**: Sensor Fabrication And Analog-Based ML Development

- ▶ Study BNL-fabricated sensors with varying gain layer doses from $2.8 \cdot 10^{12} \text{ cm}^{-2}$ to $2.25 \cdot 10^{12} \text{ cm}^{-2}$
- ▶ Study different how behaviors as a function of different pad patterns



- ▶ Training based on both TCTs and test beams
- ▶ Investigate noise mitigation techniques with attention mechanisms and/or adversarial training.
- ▶ Optimize geometry based on application.
- ▶ Study performance as a function of sensor irradiation

- **O2**: Digital Readout And Firmware Development

- ▶ Transition from proof-of-concept to FPGA implementation
- ▶ Study the amount of compression needed for maintaining targeted spatial precision

Conclusion/Collaborations

- Optimizing the information contained in the charge collection of RSD will:
 - ▶ Accelerate the goals of achieving improved spatial resolution with current production technologies.
 - ▶ Drive future technologies toward optimized designs,
 - ▶ Output of this effort in the context of RG 2.3 area.
- Participants:
 - ▶ Brown University: sensor characterization, ML implementation, and readout development.
 - ▶ Brookhaven National Laboratory: sensor fabrication and readout development.
 - ▶ University of Zurich: FEE design, sensor, and hybrid characterization, test beam setup.
- Resources:
 - ▶ Personpower: staggered approach for **○1** and **○2**.
 - ◆ 2 to 4 FTE of personpower to reach its targets:
 - ◆ ~1 FTE of project guidance: 0.4 from Brown University and 0.2 and 0.2 from UZH and Brookhaven National Laboratory,
 - ◆ 1 to 2 transient appointments
 - ▶ Characterization facilities in UZH, Brown, and BNL and Sensor fabrication at BNL.
 - ▶ Further resources (inc. personpower) are envisioned through future funding requests.
- Collaborations and coactions within the DRD3 Collaboration at CERN:
 - ▶ Open to collaboration with facilities (WG5).
 - ▶ Benefit from shared resources and joining of new persons in the team.
 - ▶ Coactions with TCAD simulations are used to emulate RSDs' response.
 - ▶ Collaboration with further readout experts towards full testing in complete hybrids.

Additional material.

Bonding scheme

